When

Wednesday June 30, 2010 5:00 PM

Where

FSD

20700 Civic Center Dr. Suite 450 Southfield, MI 48076

Mailing Link

Join Our Mailing List



Annual Sponsor





If you think we rocked in 2009, 2010 can only get better! TiECon Midwest 2010 is back- stronger, more resourceful and more powerful!

Calling Volunteers for Business Karma 3.0 - Create. Connect. Collaborate.

Why should you become a hot shot Volunteer for TiEcon Midwest 2010?

- Attend the two-day Michigan's largest entrepreneurial conference TiECon Midwest 2010 for FREE
- Attend the exclusive networking sessions with industry experts and venture capitalists
- interact personally with panel speakers, industry luminaries, key note speakers and TiE Charter Members
- Learn how to network and build your business connections the inside knowledge counts

How does it work?

Not a hierarchical structure. Sign up for what you can deliver!

Pick your area of interest from the choicest industries and hot topics. Includes but not limited to:

- Business Plan Competition
- TiE Midwest 20
- Extreme Networking events
- Registration, IT, Marketing & PR, Sales, Sponsorship and Scouting Speakers

Agenda

5:00 - 6.00 p.m. Networking & Dinner

6:00 p.m. Kick Off Meeting & Presentation by Chairs

7.30 p.m. Volunteer Assignments

8:00 p.m. Q & A

To attend the volunteer meeting and also to select the team that you would be interested in volunteering, please select the link below.

If you can't attend this meeting, but would like to volunteer, please contact Anu Gopalakrishnan, Operations Chair.

(248)345-9652 anu@tieconmidwest.org

YES - I will attend

Please visit www.tieconmidwest.org to learn more

To find out more about the description and deliverables of various teams, please select the link.

I would very much appreciate if you can share the facebook links and tweet (at the bottom of the flyer which is shown as share) to your friends and help recruit volunteers for a life changing experience working with the best minds in town.

Partner Event

Lawrence Tech invites you to participate in the

Innovation & Entrepreneurship Needs Assessment Survey

sponsored by a U.S. Department of Commerce, Economic Development Administration grant. Best Regards,



Tel K. Ganesan President, TiE Detroit

President, Kyyba Ventures

